

Fast-Metal Minute Adhesive



Pasty Fast-curing Epoxy Adhesive Syringe

WEICON Fast-Metal Minute Adhesive is ideal for repairs and bondings with larger bonding gaps or bigger tolerances. The gap filling properties make it suitable for rough and poorly fitting surfaces but also to fill in cracks, cavities and unlevelled surfaces.

Fast-Metal Minute Adhesive can be used on numerous materials such as metal, plastic, fibre reinforced materials, ceramics, glass, stone and wood.

Technical Data

Base	Epoxy resin highly filled
Texture	paste consistency, crack-filler
Colour	grey
Mixing ratio by weight (Resin / Hardener)	1:1
Density of the mixture	1,8 g/cm ³
Viscosity of the mixture at 20°C (+68°F)	300.000 mPa·s
Adhesive gap bridging up to max.	4 mm
Processing temperature	(+50°F) +10 to (+86°F) +30 °C
Curing temperature	(+43°F) +6 to (+104°F) +40 °C
Pot life at 20°C (+68°F) for 10ml material	3 -4 min.
Handling strength (35% strength) after	40 min.
Capable of bearing mechanical loads (50% strength) a	fter 2 h
Final strength (100%) after	24 h
Medium strength of the pure epoxy resin according to	DIN EN 1465
Pressure	10 Mpa
Pull	24 Mpa
Bending	58 Mpa
E-Modul	4.000 - 4.500 Mpa
Shore hardness D	70
Medium shear strength according to DIN EN 1465 at	
Steel sand blasted	20 N/mm²

Alu sandblasted	19 N/mm²
PVC hard-roughened	11 N/mm²
Linear shrinkage	0,3 %
Temperature resistance	(-58°F) -50 to (+293°F) +145 °C
Thermal diffusivity (23 °C)	0,286 mm²/s
Thermal conductivity	0,51 W/m·K
Specific heat capacity	0,904 J/(g·K)
Resistivity	4,57 · 10^12 Ωm
ISSA-Code	75.629.51
IMPA-Code	812981

Surface pre-treatment

To ensure a perfect bond, the surfaces to be joined must be clean and dry (e.g., clean and degrease using WEICON Surface Cleaner).

Processing

WEICON Easy-Mix products can be processed directly from the double cartridges with the help of the included static mixer. Reject the first 5 cm of the dosed bead. Apply adhesive to only one of the surfaces to be bonded. The pot life given is for a material quantity of 10 ml at room temperature. If larger quantities are used, the curing time will be faster. Similarly, higher ambient temperatures shorten the cure times (as a rule of thumb, every +10°C increase above room temperature will halve working and curing time). Temperatures below +16°C will extend working and curing times considerably, while below about +5°C, no reaction will take place at all.

Storage

When kept at a constant room temperature of about +20°C and unopened in dry conditions, WEICON Epoxy Adhesives will keep for at least 18 months. Avoid direct sunlight. If these storage instructions are disregarded, the storage life will be reduced to six months. Epoxy resins are fundamentally liable to crystallise at temperatures of less than +5°C. This effect is accentuated by wide variations in temperature such as can frequently occur during transport in winter. This also has a negative effect on working qualities, curing and technical details, although these effects can be reversed by warming up to a maximum of +50°C (no naked flame). In the case of WEICON Epoxy Adhesives, careful selection and combination of the base resins (bisphenol A and F) ensures a reduction of crystallisation.

Safety and health

When using WEICON products, the physical, safety technical, toxicological and ecological data and regulations in our EC safety data sheets (www.weicon.com) must be observed.

Available sizes:

10551024-35 Fast-Metal Minute Adhesive 24 ml

Note

The specifications and recommendations given in this technical data sheet must not be seen as guaranteed product characteristics. They are based on our laboratory tests and on practical experience. Since individual application conditions are beyond our knowledge, control and responsibility, this information is provided without any obligation. We do guarantee the continuously high quality of our products. However, own adequate laboratory and practical tests to find out if the product in question meets the requested properties are recommended. A claim cannot be derived from them. The user bears the only responsibility for non-appropriate or other than specified applications.

WEICON GmbH & Co. KG (Headquarters) Germany phone +49 (0) 251 9322 0 info@weicon.de www.weicon.de

WEICON SA (Pty) Ltd South Africa phone +27 (0) 21 709 0088 info@weicon.co.za www.weicon.co.za WEICON Middle East L.L.C. United Arab Emirates phone +971 4 880 25 05 info@weicon.ae www.weicon.ae

WEICON South East Asia Pte Ltd Singapore phone (+65) 6710 7671 info@weicon.com.sg www.weicon.com.sg WEICON Inc. Canada phone +1 877 620 8889 info@weicon.ca www.weicon.ca

WEICON Czech Republic s.r.o. Czech Republic phone +42 (0) 417 533 013 info@weicon.cz WEICON Kimya Sanayi Tic. Ltd. Şti. Turkey phone +90 (0) 212 465 33 65 info@weicon.com.tr www.weicon.com.tr

WEICON Ibérica S.L. Spain phone +34 (0) 914 7997 34 info@weicon.es www.weicon.es WEICON Romania SRL Romania phone +40 (0) 3 65 730 763 office@weicon.com www.weicon.com.ro

WEICON Italia S.r.I. Italy phone (+39) 0102924871 info@weicon.it www.weicon.it